## **Fully Integrated Battery Charger with Two Step-Down Converters**

### **General Description**

The RT9511 is a fully integrated low cost solution with a single-cell Li-Ion battery charger and two high efficiency step-down DC/DC converters ideal for portable applications.

The Battery Charger is capable of being powered up from AC adapter and USB (Universal Serial Bus) port inputs which can automatically detect and select the AC adapter and the USB port as the power source for the charger. The Battery Charger enters sleep mode when both supplies are removed. The Battery Charger optimizes the charging task by using a control algorithm including preconditioning mode, fast charge mode and constant voltage mode. The charging task is terminated as the charge current drops below the preset threshold. The USB charge current can be selected from preset ratings100mA and 500mA, while the AC adapter charge current can be programmed up to 1A with an external resister. The internal thermal feedback circuitry regulates the die temperature to optimize the charge rate for all ambient temperatures. The Battery Charger features 18V and 7V maximum rating voltages for AC adapter and USB port inputs respectively. The other features are external programmed safety timer, under voltage protection, over voltage protection for AC adapter supply, battery temperature monitoring and charge status indicator.

The high-efficiency step-down DC/DC converter is capable of delivering 1A output current over a wide input voltage range from 2.5V to 5.5V, the step-down DC/DC converter is ideally suited for portable electronic devices that are powered from 1-cell Li-ion battery or from other power sources such as cellular phones, PDAs and hand-held devices. Two operating modes are available including : PWM/Low-Dropout autoswitch and shut-down modes. The Internal synchronous rectifier with low  $R_{DS(ON)}$  dramatically reduces conduction loss at PWM mode. No external Schottky diode is required in practical application.

The RT9511 is available in a WQFN -24L 4x4 package.

### **Features**

- **Battery Charger** 
	- ` **Automatic Input Supplies Selection**
	- ` **18V Maximum Rating for AC Adapter**
	- ` **Integrated Selectable 100mA and 500mA USB Charge Current**
	- ` **Internal Integrated Power FETs**
	- ` **Charge Status Indicator**
	- ` **External Capacitor Programmable Safety Timer**
	- ` **Under Voltage Protection**
	- ` **Over Voltage Protection**
	- ` **Automatic Recharge Feature**
	- ` **Battery Temperature Monitoring**
	- ` **Thermal Feedback Optimizing Charge Rate**
	- ` **Power Path Controller**
- **Step-Down DC/DC Converter** 
	- ` **Adjustable Output from 0.6V to VIN**
	- ` **1A Output Current**
	- ` **95% Efficiency**
	- ` **No Schottky Diode Required**
	- ` **1.5MHz Fixed-Frequency PWM Operation**
- **Small 24-Lead WQFN Package**
- **RoHS Compliant and Halogen Free**

### **Applications**

- MP3/MP4 Player
- $\bullet$  GPS
- Digital Photo Frame
- Hand held Device

## **Marking Information**

For marking information, contact our sales representative directly or through a Richtek distributor located in your area.



## **Ordering Information**

### RT9511<sup> $\Box$ </sup> Package Type QW : WQFN-24L 4x4 (W-Type) Lead Plating System G : Green (Halogen Free and Pb Free)

Note :

Richtek products are :

- } RoHS compliant and compatible with the current require ments of IPC/JEDEC J-STD-020.
- } Suitable for use in SnPb or Pb-free soldering processes.

### **Pin Configurations**



## **Typical Application Circuit**



## **Functional Pin Description**



## **Function Block Diagram**



# **RT9511**





## **Absolute Maximum Ratings** (Note 1)



## **Recommended Operating Conditions** (Note 4)



### **Electrical Characteristics**

( $V_{ACIN}$  =  $V_{USB}$  = 5V,  $T_A$  = 25°C, unless otherwise specification)



*To be continued*

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	<b>Parameter</b>	Symbol	<b>Test Conditions</b>	Min	<b>Typ</b>	Max	Unit
Full Charge Setting Range		<sup>I</sup> CHG_AC		50	$-$	1000	mA
<b>AC Charge Current Accuracy</b>		$I_{CHG\_AC}$	$V_{BATT} = 3.8V$ , $R_{ISET} = 1.5k\Omega$	$\overline{\phantom{a}}$	500	$-$	mA
Precharge							
<b>BATT Pre-charge Threshold</b>		<b>VPRECH</b>		2.7	2.8	2.9	V
<b>BATT Pre-charge Threshold</b> Hysteresis		$\Delta V$ PRECH		60	100	140	mV
Pre-Charge Current		<b>I</b> PCHG	$VBATT = 2V$	8	10	12	$\%$
<b>Recharge Threshold</b>							
<b>BATT Re-charge Falling Threshold</b> <b>Hysteresis</b>		$\Delta V_{RECH\_L}$		50	95	140	mV
	<b>Charge Termination Detection</b>						
<b>Termination Current Ratio</b> (Note 5)		<b>ITERM</b>	$VBATT = 4.2V$	$\overline{\phantom{a}}$	10	--	$\%$
Logic Input/Output							
	CHG S Pull Down Voltage		$l$ <sub>CHG</sub> $s = 5mA$	$\overline{a}$	213	$-$	mV
<b>EN</b> Threshold	Logic-High	V <sub>IH</sub>		1.5	$-$	$-$	V
Voltage	Logic-Low	$V_{IL}$		$\overline{\phantom{a}}$	$-$	0.4	V
EN Pin Input Current		IEN		$\mathord{\hspace{1pt}\text{--}\hspace{1pt}}$	$- -$	1.5	μA
<b>ISETU</b> Threshold	High Voltage	V <sub>ISETU_HIGH</sub>		1.5	$-$		V
	Low Voltage	VISETU LOW		$-$	$-$	0.4	V
<b>ISETU Pin Input Current</b>		<b>I</b> ISETU		$\mathord{\hspace{1pt}\text{--}\hspace{1pt}}$	$-$	1.5	μA
	<b>USB Charge Current &amp; Timing</b>						
Soft-Start Time		$T_{SS}$	$V_{\text{ISETA}}$ from 0V to 2.5V	$- -$	100	$\overline{\phantom{a}}$	μs
<b>USB Charge Current</b>		ICHG_USB	$V_{ACIN}$ = 3.5V, $V_{USE}$ = 5V, $V_{BATT} = 3.5V, I_{SETU} = 5V$	400	450	500	mA
<b>USB Charge Current</b>		ICHG_USB	$V_{ACIN} = 3.5V$ , $V_{USE} = 5V$ , $V_{BATT} = 3.5V, I_{SETU} = 0V$	60	80	100	mA
Timer							
<b>TIME Pin Source Current</b>		<b>ITIME</b>	$V_{TIMER} = 2V$	44	1	44	μA
Pre-charge Fault Time		T <sub>PCHG_F</sub>	$C_{TIMER} = 0.1 \mu F, f_{CLK} = 7 Hz$	1720	2460	3200	s
Charge Fault Time		T <sub>FCHG</sub> <sub>F</sub>	$C_{TIMER} = 0.1 \mu F$ , $f_{CLK} = 7 Hz$	13790	19700	25610	s
	<b>Battery Temperature Sense</b>						
TS Pin Source Current		I <sub>TS</sub>	$V_{TS} = 1.5V$	96	102	108	μA
TS Pin Threshold	High Voltage	V <sub>TS_HIGH</sub>		0.485	0.5	0.515	V
	Low Voltage	V <sub>TS_LOW</sub>		2.45	2.5	2.55	V
<b>Protection</b>							
<b>Thermal Regulation</b>				$\overline{\phantom{a}}$	125	$-$	$^{\circ}$ C
<b>OVP SET Voltage</b>			Internal Default	$- -$	6.5	$-$	V
Power Path Controller							
<b>BAT_ON Pull Low</b>			As SYS Falling, $V_{BATT} = 4V$ , SYS-BAT	$-150$	$\mathord{\hspace{1pt}\text{--}\hspace{1pt}}$	$-20$	mV

*To be continued*





#### **Step-Down Converter**

(V $_{\rm DD1,~2}$  = 3.6V, V $_{\rm OUT1,~2}$  = 2.5V, L = 2.2 $\mu$ H, C $_{\rm IN1,~2}$  = 4.7 $\mu$ F, C $_{\rm OUT1,~2}$  = 10 $\mu$ F, I $_{\rm MAX}$  = 1A, T $_{\rm A}$  = 25°C, unless otherwise specification)



- **Note 1.** Stresses listed as the above "Absolute Maximum Ratings" may cause permanent damage to the device. These are for stress ratings. Functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may remain possibility to affect device reliability.
- Note 2. θ<sub>JA</sub> is measured in the natural convection at T<sub>A</sub> = 25°C on a high effective four layers thermal conductivity test board of JEDEC 51-7 thermal measurement standard. The case point of θ<sub>JC</sub> is on the expose pad for the WQFN package.
- **Note 3.** Devices are ESD sensitive. Handling precaution is recommended.
- **Note 4.** The device is not guaranteed to function outside its operating conditions.
- **Note 5.** Guarantee by design.
- **Note 6.**  $\Delta V = I$  OUT X PRDS(ON)



## **Typical Operating Characteristics**









**Enable Threshold Voltage vs. Input Voltage** 2.0  $V_{BAT} = 3.8V$ , Icharger = 500mA



**ISETA Voltage vs. Temperature**



**TS Current vs. Temperature**







#### Step-Down Converter















### **Application Information**

The RT9511 is a fully integrated low cost single-cell Li-Ion battery charger and two high-efficiency step-down DC-DC converters ideal for portable applications.

#### **Battery Charger**

#### **Automatically Power Source Selection**

The RT9511 can be adopted for two input power source, ACIN and USB Inputs. It will automatically select the input source and operate in different mode as below.

**ACIN Mode**: When the adapter input voltage  $(V_{ACIN})$  is higher than the UVP voltage level (4.3V), the RT9511 will enter ACIN Mode. In the ACIN Mode, ACIN P-MOSFET is turned on and USB P-MOSFET is turned off. When ACIN voltage is between the UVP and OVP threshold levels, the switch Q1 will be turned on and Q2 will be turned off. So, the system load is powered directly from the adapter through the transistor Q1, and the battery is charged by the RT9511. Once the ACIN voltage is higher than the OVP or is lower than the UVP threshold, the RT9511 stops charging, and then Q1 will be turned off and Q2 will be turned on to supply the system by battery.

**USB Mode** : When ACIN voltage is lower than UVP voltage level and USB input voltage is higher than UVP voltage level (3.9V), the RT9511 will operate in the USB Mode. In the USB Mode, ACIN P-MOSFET and Q1 are turned off and USB P-MOSFET and Q2 are turned on. The system load is powered directly from the USB/Battery through the switch Q2. Note that in this mode, the battery will be discharged once the system current is higher than the battery charge current.

**Sleep Mode** : The RT9511 will enter Sleep Mode when both ACIN and USB input voltage are removed. This feature provides low leakage current from the battery during the absence of input supply.



#### **Power-Path Management**

The RT9511 powers the system and independently charging the battery while the input is ACIN. This feature reduces the charge time, allows for proper charge termination, and allows the system to run with an absent or defective battery pack.

#### **Case 1 : Input is ACIN**

In this case, the system load is powered directly from the AC adapter through the transistor Q1. For the RT9511, Q1 and Q2 act as a switch as long as the RT9511 is ready. Once the ACIN voltage is ready (>UVP and <OVP), the battery is charged by the RT9511 internal MOSFET and Q1 starts regulating the output voltage supply system (Q2 is turn off). Once the ACIN voltage is over operation voltage (<UVP or >OVP), the RT9511 stops charging the battery, Q1 turns off and Q2 starts to supply power for system.



#### **Case 2 : Input is USB**

In this case, the system load is powered directly from the battery through the switch Q2 (Q1 is turn off). Note that in this case, the system current over battery charge current will lead to battery discharge.



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# **RT9511**

#### **CIN Over Voltage Protection**

The ACIN input voltage is monitored by an internal OVP comparator. The comparator has an accurate reference of 2.5V from the band-gap reference. The OVP threshold is set by the internal resistive. The protection threshold is set to 6.5V, but ACIN input voltage over 18V still leads the RT9511 to damage. When the input voltage exceeds the threshold, the comparator outputs a logic signal to turn off the power P-MOSFET to prevent the high input voltage from damaging the electronics in the handheld system. When the input over voltage condition is removed (ACIN < 6V), the comparator re-enables the output by running through the soft-start.

#### **Battery Temperature Monitoring**

The RT9511 continuously monitors battery temperature by measuring the voltage between the TS and GND pins.

The RT9511 has an internal current source to provide the bias for the most common 10kΩ negative-temperature coefficient thermal resistor (NTC) (see Figure 5). The RT9511 compares the voltage on the TS pin against the internal VTS\_HIGH and VTS\_LOW thresholds to determine if charging is allowed. When the temperature outside the VTS\_HIGH and VTS\_LOW thresholds is detected, the device will immediately stop the charge. The RT9511 stops charging and keep monitoring the battery temperature when the temperature sense input voltage is back to the threshold between VTS\_HIGH and VTS\_LOW, the charger will be resumed. Charge is resumed when the temperature returns to the normal range. However, the user may modify thresholds by the negative-temperature coefficient thermal resistor or adding two external resistors. (see Figure 6.)

The capacitor should be placed close to TS (Pin 9) and connected to the ground plane. The capacitance value (0.1µF to 10µF) should be selected according to the quality of PCB layout. It is recommended to use a 10µF if the layout is poor to prevent noise.



 $V_{TS} = I_{TS} \times R_{NTC}$ Turn off when  $\mathsf{V}_{\mathsf{TS}} \geq 2.5 \mathsf{V}$  or  $\mathsf{V}_{\mathsf{TS}} \leq 0.5 \mathsf{V}$ 

Figure 5. Temperature Sensing Configuration



$$
V_{TS} = I_{TS} \frac{R_{T2} \times (R_{T1} + R_{NTC})}{R_{T1} + R_{T2} + R_{NTC}}
$$
  
Turn off when  $V_{TS} \ge 2.5V$  or  $V_{TS} \le 0.5V$ 

Figure 6. Temperature Sensing Circuit

#### **Fast-Charge Current Setting**

#### **Case 1: ACIN Mode**

The RT9511 offers ISETA pin to determine the ACIN charge rate from 100mA to 1.2A. The charge current can be calculated as following equation.

$$
I_{charge\_ac} = K_{SET} \frac{V_{SET}}{R_{SETA}}
$$

The parameter  $K_{\text{SET}} = 300$ ;  $V_{\text{SET}} = 2.5V$ . R<sub>SETA</sub> is the resistor connected between the ISETA and GND.



Figure 7. ACIN Mode Charge Current Setting

#### **Case 2 : USB Mode**

When charging from a USB port, the ISETU pin can be used to determine the charge current of 100mA or 500mA.

A low-level signal of the ISETU pin sets the charge current at 100mA and a high level signal sets the charge current at 500mA.

#### **Pre- Charge Current Setting**

During a charge cycle if the battery voltage is below the V<sub>PRECH</sub> threshold, the RT9511 applies a pre-charge mode to the battery. This feature revives deeply discharged cells and protects battery life. The RT9511 internally determines the pre-charge rate as 10% of the fast-charge current.

#### **Battery Voltage Regulation**

The RT9511 monitors the battery voltage through the BATT pin. Once the battery voltage level closes to the  $V_{REG}$ threshold, the RT9511 voltage enters constant phase and the charging current begins to taper down. When battery voltage is over the  $V_{\text{REG}}$  threshold, the RT9511 will stop charge and keep to monitor the battery voltage. However, when the battery voltage decreases 100mV below the  $V<sub>REG</sub>$ , it will be recharged to keep the battery voltage.

#### **Charge Status Outputs**

The open-drain CHG S output indicates various charger operations as shown in the following table. These status pin can be used to drive LEDs or communicate to the host processor. Note that ON indicates the open-drain transistor is turned on and LED is bright.



#### **Temperature Regulation and Thermal Protection**

In order to maximize the charge rate, the RT9511 features a junction temperature regulation loop. If the power dissipation of the IC results in a junction temperature greater than the thermal regulation threshold (125°C), the RT9511 throttles back on the charge current in order to maintain a junction temperature around the thermal regulation threshold (125°C). The RT9511 monitors the junction temperature,  $T_{J}$ , of the die and disconnects the battery from the input if  $T_J$  exceeds 125 $\degree$ C. This operation continues until junction temperature falls below thermal regulation threshold (125°C) by the hysteresis level. This feature prevents the maximum power dissipation from exceeding typical design conditions.

#### **External Timer**

As a safety mechanism, the RT9511 has a userprogrammable timer that monitors the pre-charge and fast charge time. This timer (charge safety timer) is started at the beginning of the pre-charge and fast charge period. The safety charge timeout value is set by the value of an external capacitor connected to the TMR pin  $(C_{TMB})$ , if pin TMR is short to GND, the charge safety timer is disabled.

As  $C_{TMR} = 0.1 \mu F$ ,  $T_{PRECH}$  is ~2460 secs and  $T_{FAULT}$  is 8 x  $T_{PRECH}$ .  $T_{PRECH}$  =  $C_{TMR}$  x 2460/0.1 $\mu$ 

As timer fault, re-plug-in power or pull high and re-pull low EN can release the fault condition.

As a safety mechanism, the RT9511 has a userprogrammable timer that monitors the pre-charge and fast charge time. This timer (charge safe timer) is started at the beginning of the pre-charge and fast-charge period. The safety charge timeout value is set by an external capacitor (CT) connected between TIMER pin and GND. The timeout fault condition can be released by resetting the input power or the EN pin. If the TIMER is shorted to GND, the charge safety timer will be disabled.



# **RT9511**

#### **Selecting the Input and Output Capacitors**

In most applications, the most important is the high frequency decoupling capacitor on the input of the RT9511.

A 1µF ceramic capacitor, placed in close proximity to input pin and GND pin is recommended. In some applications depending on the power supply characteristics and cable length, it may be necessary to add an additional 10µF ceramic capacitor to the input. The RT9511 requires a small output capacitor for loop stability. A 1uF ceramic capacitor placed between the BATT pin and GND is typically sufficient.

#### **Step-Down DC-DC Converters**

#### **Inductor Selection**

For a given input and output voltage, the inductor value and operating frequency determine the ripple current. The ripple current  $\Delta I_L$  increases with higher V<sub>IN</sub> and decreases with higher inductance.



Having a lower ripple current reduces the ESR losses in the output capacitors and the output voltage ripple. Highest efficiency operation is achieved at low frequency with small ripple current. This, however, requires a large inductor.

A reasonable starting point for selecting the ripple current is  $\Delta I_L = 0.4(I_{MAX})$ . The largest ripple current occurs at the highest  $V_{IN}$ . To guarantee that the ripple current stays below a specified maximum, the inductor value should be chosen according to the following equation :

$$
L = \left[\frac{V_{OUT}}{f \times \Delta I_{L(MAX)}}\right] \times \left[1 - \frac{V_{OUT}}{V_{IN(MAX)}}\right]
$$

#### **Inductor Core Selection**

Once the value for L is known, the type of inductor must be selected. High efficiency converters generally cannot afford the core loss found in low cost powdered iron cores, forcing the use of more expensive ferrite or mollypermalloy cores. Actual core loss is independent of core size for a fixed inductor value but it is very dependent on the inductance selected. As the inductance increases, core losses decrease. Unfortunately, increased inductance requires more turns of wire and therefore copper losses will increase.

Ferrite designs have very low core losses and are preferred at high switching frequencies, so design goals can concentrate on copper loss and preventing saturation. Ferrite core material saturates "hard", which means that inductance collapses abruptly when the peak design current is exceeded. This results in an abrupt increase in inductor ripple current and consequent output voltage ripple.

Do not allow the core to saturate! Different core materials and shapes will change the size/ current and price/current relationship of an inductor.

Toroid or shielded pot cores in ferrite or permalloy materials are small and don't radiate energy but generally cost more than powdered iron core inductors with similar characteristics. The choice of which style inductor to use mainly depends on the price vs. size requirements and any radiated field/EMI requirements.

#### **CIN and COUT Selection**

The input capacitance,  $C_{\text{IN}}$ , is needed to filter the trapezoidal current at the source of the top MOSFET. To prevent large ripple voltage, a low ESR input capacitor sized for the maximum RMS current should be used. RMS current is given by :

$$
I_{RMS} = I_{OUT(MAX)} \frac{V_{OUT}}{V_{IN}} \sqrt{\frac{V_{IN}}{V_{OUT}} - 1}
$$

This formula has a maximum at  $V_{IN} = 2V_{OUT}$ , where  $I<sub>RMS</sub> = I<sub>OUT</sub>/2$ . This simple worst-case condition is commonly used for design because even significant deviations do not offer much relief. Choose a capacitor rated at a higher temperature than required. Several capacitors may also be paralleled to meet size or height requirements in the design.

The selection of  $C_{\text{OUT}}$  is determined by the effective series resistance (ESR) that is required to minimize voltage ripple and load step transients, as well as the amount of bulk capacitance that is necessary to ensure that the control loop is stable. Loop stability can be checked by viewing the load transient response as described in a later section.

The output ripple,  $\Delta V_{\text{OUT}}$ , is determined by :

$$
\Delta V_{OUT} \leq \Delta I_L \left[ESR + \frac{1}{8fC_{OUT}}\right]
$$

The output ripple is highest at maximum input voltage since ∆I<sub>L</sub> increases with input voltage. Multiple capacitors placed in parallel may be needed to meet the ESR and RMS current handling requirements. Dry tantalum, special polymer, aluminum electrolytic and ceramic capacitors are all available in surface mount packages. Special polymer capacitors offer very low ESR but have lower capacitance density than other types. Tantalum capacitors have the highest capacitance density but it is important to only use types that have been surge tested for use in switching power supplies. Aluminum electrolytic capacitors have significantly higher ESR but can be used in cost-sensitive applications provided that consideration is given to ripple current ratings and long term reliability. Ceramic capacitors have excellent low ESR characteristics but can have a high voltage coefficient and audible piezoelectric effects.

The high Q of ceramic capacitors with trace inductance can also lead to significant ringing.

#### **Using Ceramic Input and Output Capacitors**

Higher values, lower cost ceramic capacitors are now becoming available in smaller case sizes. Their high ripple current, high voltage rating and low ESR make them ideal for switching regulator applications. However, care must be taken when these capacitors are used at the input and output. When a ceramic capacitor is used at the input and the power is supplied by a wall adapter through long wires, a load step at the output can induce ringing at the input,  $V_{\text{IN}}$ . At best, this ringing can couple to the output and be mistaken as loop instability. At worst, a sudden inrush of current through the long wires can potentially cause a voltage spike at  $V_{\text{IN}}$  large enough to damage the part.

#### **Output Voltage Programming**

The resistive divider allows the FB pin to sense a fraction of the output voltage as shown in Figure 8.





$$
V_{OUT} = V_{REF}(1+\frac{R1}{R2})
$$

where  $V_{REF}$  is the internal reference voltage (0.6V typ.)

#### **Efficiency Considerations**

The efficiency of a switching regulator is equal to the output power divided by the input power times 100%. It is often useful to analyze individual losses to determine what is limiting the efficiency and which change would produce the most improvement. Efficiency can be expressed as :

Efficiency =  $100\% - (L1 + L2 + L3 + ...)$ 

where L1, L2, etc. are the individual losses as a percentage of input power. Although all dissipative elements in the circuit produce losses, two main sources usually account for most of the losses:  $V_{IN}$  quiescent current and  $I<sup>2</sup>R$ losses.

The  $V_{\text{IN}}$  quiescent current loss dominates the efficiency loss at very low load currents whereas the  $I^2R$  loss dominates the efficiency loss at medium to high load currents. In a typical efficiency plot, the efficiency curve at very low load currents can be misleading since the actual power lost is of no consequence.

1. The  $V_{\text{IN}}$  quiescent current appears due to two factors including : the DC bias current as given in the electrical characteristics and the internal main switch and synchronous switch gate charge currents. The gate charge current results from switching the gate capacitance of the internal power MOSFET switches. Each time the gate is switched from high to low to high again, a packet of charge ∆Q moves from V<sub>IN</sub> to ground.

The resulting  $\Delta Q/\Delta t$  is the current out of V<sub>IN</sub> that is typically larger than the DC bias current. In continuous mode,  $I_{GATECHG} = f (QT + QB)$ 

where  $Q_T$  and  $Q_B$  are the gate charges of the internal top and bottom switches. Both the DC bias and gate charge losses are proportional to  $V_{IN}$  and thus their effects will be more pronounced at higher supply voltages. 2.  $1^{2}R$ losses are calculated from the resistances of the internal switches,  $R_{SW}$  and external inductor  $R_1$ . In continuous

mode, the average output current flowing through inductor L is "chopped" between the main switch and the synchronous switch. Thus, the series resistance looking into the LX pin is a function of both top and bottom MOSFET  $R_{DS(ON)}$  and the duty cycle (DC) as follows :

 $R_{SW} = R_{DS(ON)TOP} \times DC + R_{DS(ON)BOT} \times (1-DC)$ 

The  $R_{DS(ON)}$  for both the top and bottom MOSFETs can be obtained from the Typical Performance Characteristics curves. Thus, to obtain  $I^2R$  losses, simply add  $R_{SW}$  to  $R_L$ and multiply the result by the square of the average output current.

Other losses including  $C_{IN}$  and  $C_{OUT}$  ESR dissipative losses and inductor core losses generally account for less than 2% of the total loss.

#### **Checking Transient Response**

The regulator loop response can be checked by looking at the load transient response. Switching regulators take several cycles to respond to a step in load current. When a load step occurs,  $V_{\text{OUT}}$  immediately shifts by an amount equal to ∆I<sub>LOAD</sub> (ESR), where ESR is the effective series resistance of C<sub>OUT</sub>.  $\Delta I_{\text{LOAD}}$  also begins to charge or discharge  $C_{\text{OUT}}$  generating a feedback error signal used by the regulator to return  $V_{\text{OUT}}$  to its steady-state value.

During this recovery time,  $V_{\text{OUT}}$  can be monitored for overshoot or ringing that would indicate a stability problem.

#### **Thermal Considerations**

For continuous operation, do not exceed absolute maximum operation junction temperature. The maximum power dissipation depends on the thermal resistance of IC package, PCB layout, the rate of surroundings airflow and temperature difference between junction to ambient. The maximum power dissipation can be calculated by following formula :

#### $P_{D(MAX)} = (T_{J(MAX)} - T_A) / \theta_{JA}$

Where  $T_{J(MAX)}$  is the maximum operation junction temperature 125 $\degree$ C, T<sub>A</sub> is the ambient temperature and the  $\theta_{\text{JA}}$  is the junction to ambient thermal resistance.

For recommended operating conditions specification of the RT9511, the maximum junction temperature is 125°C. The junction to ambient thermal resistance  $\theta_{JA}$  is layout dependent. For WQFN-24L 4x4 packages, the thermal

resistance  $\theta_{JA}$  is 52°C/W on the standard JEDEC 51-7 four layers thermal test board. The maximum power dissipation at  $T_A = 25^{\circ}$ C can be calculated by following formula :

 $P_{D(MAX)} = (125^{\circ}C - 25^{\circ}C) / (52^{\circ}C/W) = 1.923W$  for WQFN-24L 4x4 packages

The maximum power dissipation depends on operating ambient temperature for fixed  $T_{J(MAX)}$  and thermal resistance  $\theta_{JA}$ . For RT9511 packages, the Figure 9 of derating curves allows designers to see the effect of rising ambient temperature on the maximum power dissipation allowed.



Figure 9. Derating Curves for RT9511 Packages

#### **Layout Consideration**

The RT9511 is a fully integrated solution for portable applications including a single-cell Li- Ion battery charger and two ideal high-efficiency step-down DC-DC converters ideal. Careful PCB layout is necessary. For best performance of the RT9511, the following guidelines should be strictly followed.

- } Input capacitors should be placed close to the IC and connected to ground plane.
- <sup>1</sup> The GND and Exposed Pad should be connected to a strong ground plane for heat sinking and noise protection.
- $\rightarrow$  The connection of  $R_{\text{SETA}}$  should be isolated from other noisy traces. The short wire is recommended to prevent noise coupling.

# **RT9511**

- } Output capacitors should be placed close to the IC and connected to ground plane to reduce noise coupling.
- } Keep the main current traces as possible as short and wide.
- } LX node of step-down DC-DC converter is with high frequency voltage swing. It should be kept at a small area.
- } Place the feedback components as close as possible to the IC and keep away from the noisy devices.







#### **Table 1. Recommended Inductors**

### Table 2. Recommended Capacitors for C<sub>IN</sub> and C<sub>OUT</sub>



## **Outline Dimension**



Note : The configuration of the Pin #1 identifier is optional, but must be located within the zone indicated.

		<b>Dimensions In Millimeters</b>	Dimensions In Inches		
Symbol	Min	Max	Min	<b>Max</b>	
A	0.700	0.800	0.028	0.031	
A1	0.000	0.050	0.000	0.002	
A <sub>3</sub>	0.175	0.250	0.007	0.010	
b	0.180	0.300	0.007	0.012	
D	3.950	4.050	0.156	0.159	
D <sub>2</sub>	2.300	2.750	0.091	0.108	
E.	3.950	4.050	0.156	0.159	
E <sub>2</sub>	2.300	2.750	0.091	0.108	
е	0.500		0.020		
	0.350	0.450	0.014	0.018	

**W-Type 24L QFN 4x4 Package**

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